



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

*In re* application of:

***Yoshihide Senzaki,***

Serial No.: **10/686,898**

Filing Date: **October 15, 2003**

For: **Two-Step Atomic Layer Deposition of  
Copper Layers**

Examiner: Bret P. Chen

Art Unit No.: 1762

Confirmation  
No.: 7540

Date: February 18, 2005

**Amendment Response**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

Sir:

This Amendment Response is in response to the Office Action dated August 18, 2004 received in connection with the above-referenced application. Accompanying this Amendment is a Petition for Extension of Time under 37 CFR 1.136(a) with proper fees, extending the period for response by three months, to February 18, 2005.

**Amendments to the Claims** are reflected in the listing of claims which begin on page 2 of this paper.

**Remarks** begin on page 5 of this paper.